## **Optocoupler with Phototransistor Output**

Order Nos. and Classification table is on sheet 2.

#### **Description**

The CQY80N(G) and CQY80NS(G) consist of a phototransistor optically coupled to a gallium arsenide infrared emitting diode in a 6 lead plastic dual inline packages. The elements are mounted on one leadframe in coplanar technique, providing a fixed distance between input and output for highest safety requirements.





#### **Applications**

Circuits for safe protective separation against electrical shock according to safety class II. (reinforced isolation):

- for application class I IV at main voltages  $\leq 300 \text{ V}$ ;
- for application class I III at main voltage ≤ 600 V according to VDE 0884, table 2, suitable for:

Switch mode power supplies, computer peripheral interface, microprocessor system interface, line receiver.





0884

These couplers perform safety functions according to following equipment standards:

- **VDE 0884** Optocoupler providing protective separation
- VDE 0804
   Telecommunication apparatus and data processing

• VDE 0805/IEC 950/EN 60950

Office machines (applied for reinforced isolation for main voltage  $\leq 400 \text{ V}_{RMS}$ )

VDE 0860/IEC 65

Safety for mains operated electronic and related apparatus for household

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#### **Features**

According to VDE 0884:

- Rated impulse voltage (transient overvoltage) V<sub>IOTM</sub> = 6 kV peak
- Isolation test voltage (partial discharge test voltage)  $V_{pd} = 1.6 \text{ kV}$
- Rated isolation voltage (RMS includes DC)
   V<sub>IOWM</sub> = 600 V<sub>RMS</sub> (848 V peak)
- Rated recurring peak voltage (repetitive)
   V<sub>IORM</sub> = 600 V<sub>RMS</sub>
- Creeping current resistance according to VDE 0303/IEC 112
   Comparative Tracking Index: CTI = 275
- Thickness through insulation  $\geq 0.75$  mm

- Further approvals:
   BS 415, BS 7002, SETI: IEC 950,
   UL 1577: File No: E 76222
- CTR > 50%
- Isolation materials according to UL94-VO
- Pollution degree 2 (DIN/VDE 0110 / resp. IEC 664)
- Climatic classification 55/100/21 (IEC 68 part 1)
- Special construction: therefore extra low coupling capacity typical 0.3 pF, high Common Mode Rejection
- Low temperature coefficient of CTR

#### **Order Schematic**

Part Numbers	CTR-Ranking
CQY80N(G)/ CQY80NS(G)	> 50%

Suffix: G = Leadform 10.16 mm

S = Waterproofed device

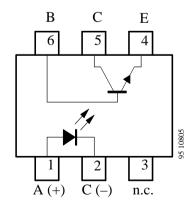
#### Remarks

For those couplers, where instead of standard soldering/cleaning process a pure water cleaning process is being used, we suggest our waterproofed construction. In this case please order the part numbers with the suffix "S". The waterproofed construction, corresponding with the coupling system "S", and does not belong to the part number itself.

Standard parts are marked with the letter "A".

This coupling system indicator "A" or "S" is in a separate (second) line of the marking.

#### **Pin Connection**



## **Absolute Maximum Ratings**

## **Input (Emitter)**

Parameters	Test Conditions	Symbol	Value	Unit
Reverse voltage		$V_R$	5	V
Forward current		$I_{\mathrm{F}}$	60	mA
Forward surge current	$t_p \le 10 \ \mu s$	I <sub>FSM</sub>	3	A
Power dissipation	$T_{amb} \le 25^{\circ}C$	P <sub>V</sub>	100	mW
Junction temperature		Ti	125	°C

## **Output (Detector)**

Parameters	Test Conditions	Symbol	Value	Unit
Collector emitter voltage		V <sub>CEO</sub>	32	V
Emitter collector voltage		V <sub>ECO</sub>	7	V
Collector current		$I_{\mathbb{C}}$	50	mA
Collector peak current	$t_p/T = 0.5, t_p \le 10 \text{ ms}$	I <sub>CM</sub>	100	mA
Power dissipation	T <sub>amb</sub> ≤ 25°C	P <sub>v</sub>	150	mW
Junction temperature		Ti	125	°C

## Coupler

Parameters	Test Conditions	Symbol	Value	Unit
Isolation test voltage (RMS)		V <sub>IO</sub>	3.75	kV
Total power dissipation	$T_{amb} \le 25^{\circ}C$	P <sub>tot</sub>	250	mW
Ambient temperature range		T <sub>amb</sub>	-55 to +100	°C
Storage temperature range		T <sub>stg</sub>	-55 to +125	°C
Soldering temperature	2 mm from case, $t \le 10 \text{ s}$	T <sub>sd</sub>	260	°C

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#### **Maximum Safety Ratings**

#### **Input (Emitter)**

Parameters	Test Conditions	Symbol	Value	Unit
Forward current		$I_{si}$	130	mA

#### **Output (Detector)**

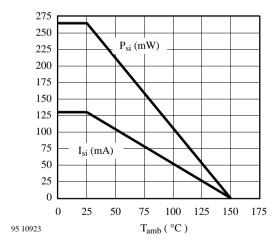
Parameters	Test Conditions	Symbol	Value	Unit
Power dissipation	$T_{amb} \le 25^{\circ}C$	$P_{si}$	265	mW

#### Coupler

Parameters	Test Conditions	Symbol	Value	Unit
Rated impulse voltage		V <sub>IOTM</sub>	6	kV
Safety temperature		$T_{si}$	150	°C

This device is used for protective separation against electrical shock only within the maximum safety ratings. This must be ensured by protective circuits in the applications.

## **Derating Diagram**



#### **Electrical Characteristics**

 $T_{amb} = 25^{\circ}C$ 

## **Input (Emitter)**

Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Forward voltage	$I_F = 50 \text{ mA}$	$V_{\mathrm{F}}$		1.25	1.6	V
Breakdown voltage	$I_C = 100 \mu A$	V <sub>(BR)</sub>	5			V
Junction capacitance	$V_R = 0$ , $f = 1$ MHz	C <sub>i</sub>		50		pF

#### **Output (Detector)**

Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Collector emitter breakdown voltage	$I_C = 1 \text{ mA}$	V <sub>(BR)CE0</sub>	32			V
Emitter collector breakdown voltage	$I_E = 100 \ \mu A$	V <sub>(BR)EC0</sub>	7			V
Collector emitter cut-off current	$\begin{aligned} V_{CE} &= 20 \text{ V, } I_f = 0, \\ E &= 0 \end{aligned}$	I <sub>CE0</sub>		10	200	nA

## Coupler

Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
AC isolation test voltage (RMS)	f = 50  Hz, t = 1  s	$V_{IO}$	3.75			V
Collector emitter saturation voltage	$I_F = 10 \text{ mA}, I_C = 1 \text{ mA}$	V <sub>CEsat</sub>			0.3	V
Cut-off frequency	$V_{CE}$ = 5 V, $I_F$ = 10 mA, $R_L$ = 100 $\Omega$	$f_c$		110		kHz
Coupling capacitance	f = 1 MHz	$C_k$		0.3		pF

## **Current Transfer Ratio (CTR)**

Parame- ters	Test Conditions	Type	Symbol	Min.	Тур.	Max.	Unit
$I_{\rm C}/I_{\rm F}$	$V_{CE} = 5 \text{ V}, I_F = 10 \text{ mA}$	CQY80N(G) CQY80NS(G)	CTR	0.5	0.9		

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## Switching Characteristics (Typical Values), $V_S = 5 \text{ V}$

Time	$R_L = 100 \text{ k}\Omega$ , see figure 1							$R_L = 1 \text{ k}\Omega$ , see fig. 2		
Type t <sub>o</sub>	t <sub>d</sub> [μs]	t <sub>r</sub> [µs]	t <sub>on</sub> [µs]	t <sub>s</sub> [µs]	t <sub>f</sub> [µs]	t <sub>off</sub> [µs]	I <sub>C</sub> [mA]	ton[µs]	t <sub>off</sub> [µs]	I <sub>F</sub> [mA]
CQY80N(G) CQY80NS(G)	4.0	7.0	11.0	0.3	6.7	7.0	5.0	25.0	42.5	10.0

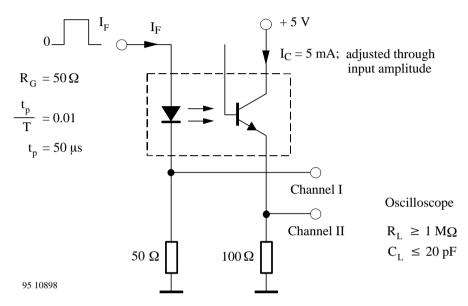


Figure 1. Test circuit

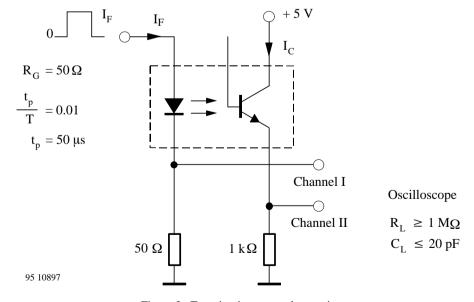


Figure 2. Test circuit, saturated operation

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## **Insulation Rated Parameters (according to VDE 0884)**

Parameters		Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Partial discharge test voltage	Routine test	100%, $t_{test} = 1 \text{ s}$	$V_{pd}$	1.6			kV
	Lot test (sample test)	$t_{Tr} = 10 \text{ s},$ $t_{test} = 60 \text{ s}$	$V_{IOTM}$	6			kV
		see figure 3	$V_{pd}$	1.3			kV
Insulation resistance		$V_{IO} = 500 \text{ V}$	$R_{IO}$	$10^{12}$			Ω
		$V_{IO} = 500 \text{ V},$ $T_{amb} = 100 ^{\circ}\text{C}$	$R_{IO}$	10 <sup>11</sup>			Ω
		$V_{IO} = 500 \text{ V},$ $T_{amb} = 150^{\circ}\text{C}$					
		(only construction test)	$R_{IO}$	$10^{9}$			$\Omega$

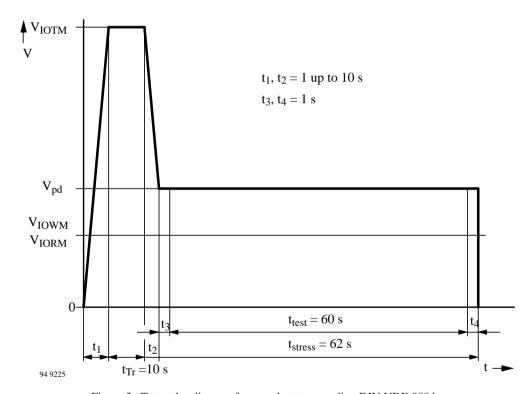
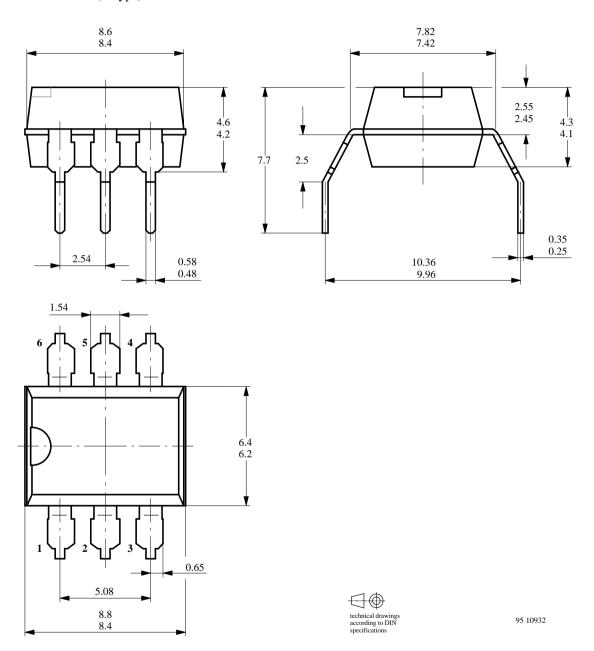


Figure 3. Test pulse diagram for sample test according DIN VDE 0884

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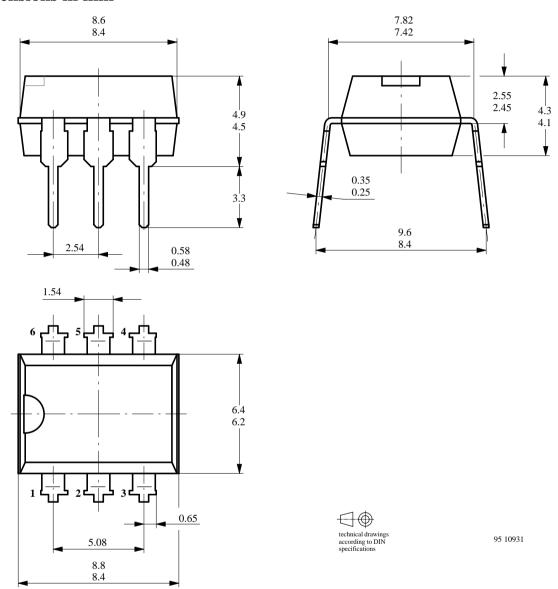
## **Dimensions in mm**

Leadform 10.16. mm (G-type)



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#### **Dimensions in mm**



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#### **Ozone Depleting Substances Policy Statement**

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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